

### ● General Description

The AGM55P10D combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ . This device is ideal for load switch and battery protection applications.

### ● Features

- Advance high cell density Trench technology
- Low  $R_{DS(ON)}$  to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

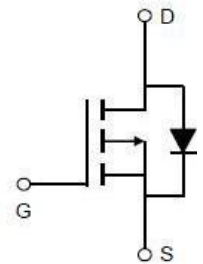
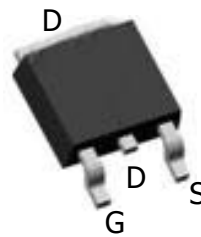
### ● Application

- MB/VGA Vcore
- SMPS 2<sup>nd</sup> Synchronous Rectifier
- POL application
- BLDC Motor driver

### Product Summary

BVDSS	RDSON	ID
-100V	52mΩ	-30A

### TO-252 Pin Configuration



### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGM55P10D	AGM55P10D	TO-252	----	----	2500

**Table 1. Absolute Maximum Ratings (TA=25°C)**

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	-100	V
VGS	Gate-Source Voltage (VDS=0V)	±20	V
ID	Drain Current-Continuous(Tc=25°C) <b>(Note 1)</b>	-30	A
	Drain Current-Continuous(Tc=100°C)	-18	A
IDM (pluse)	Drain Current-Continuous@ Current-Pulsed <b>(Note 2)</b>	-76	A
PD	Maximum Power Dissipation(Tc=25°C)	50	w
	Maximum Power Dissipation(Tc=100°C)	20	w
EAS	Avalanche energy <b>(Note 3)</b>	242	mJ
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	°C

**Table 2. Thermal Characteristic**

Symbol	Parameter	Typ	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) <sup>1</sup>	---	50	°C/W
RθJC	Thermal Resistance Junction-Case <sup>1</sup>	---	2.5	°C/W

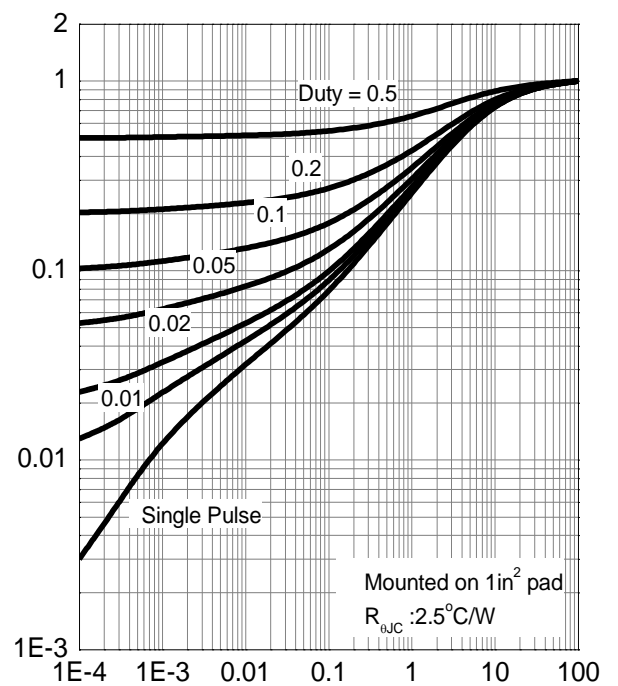
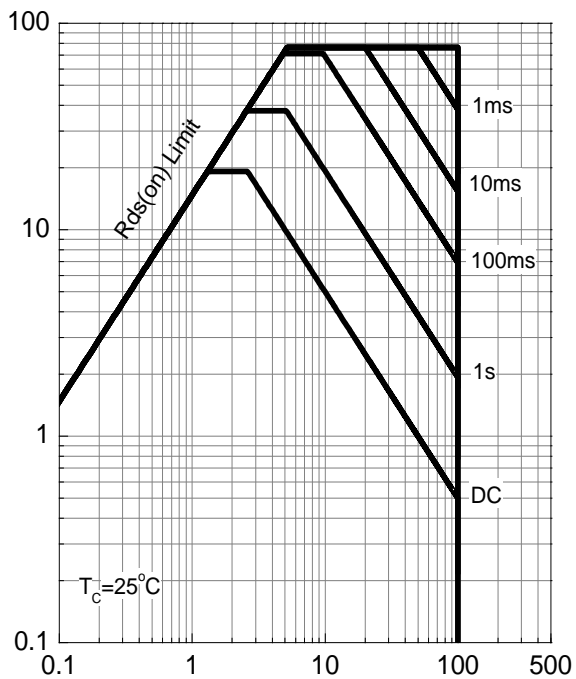
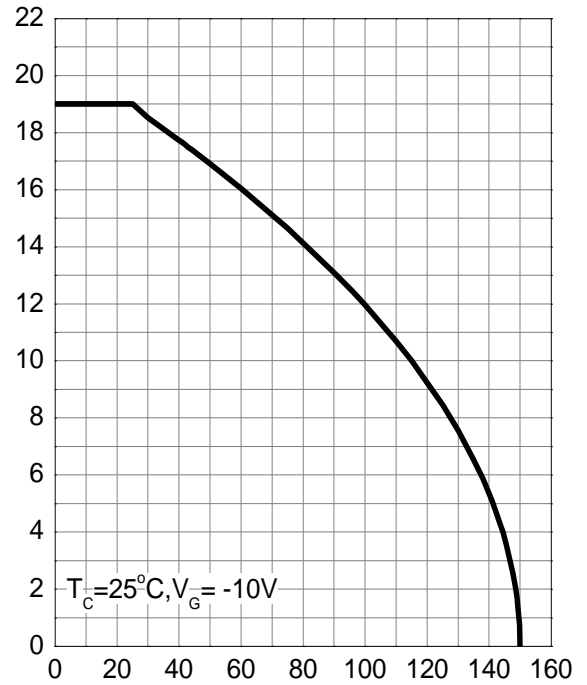
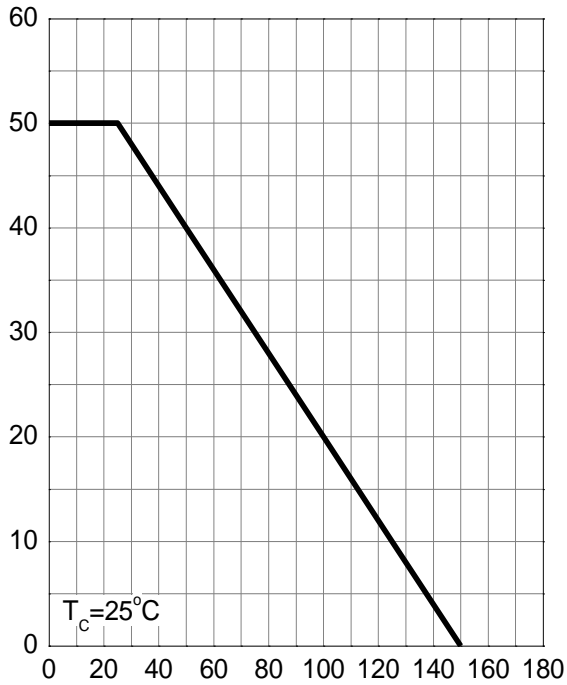
**Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>On/Off States</b>						
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=-250μA	-100	--	--	V
IDSS	Zero Gate Voltage Drain Current	VDS=-100V,VGS=0V	--	--	-1	μA
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V	--	--	±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=-250μA	-1.0	--	-2.0	V
gFS	Forward Transconductance	VDS=5V,ID=-12A	--	--	--	S
RDS(on)	Drain-Source On-State Resistance	VGS=-10V, ID=-10A	--	52	68	mΩ
		VGS=-4.5V, ID=-5A	--	63	73	mΩ
<b>Dynamic Characteristics</b>						
Ciss	Input Capacitance	VDS=-50V,VGS=0V, F=1MHZ	--	4507	--	pF
Coss	Output Capacitance		--	97	--	pF
Crss	Reverse Transfer Capacitance		--	15	--	pF
Rg	Gate resistance	VGS=0V, VDS= 0V,f=1.0MHz	--	--	--	Ω
<b>Switching Times</b>						
td(on)	Turn-on Delay Time	VGS=-10V,VDS=-50V, ID=-10A,RGEN=4.5	--	49	--	nS
tr	Turn-on Rise Time		--	71	--	nS
td(off)	Turn-Off Delay Time		--	555	--	nS
tf	Turn-Off Fall Time		--	187	--	nS
Qg	Total Gate Charge	VGS=-10V, VDS=-50V, ID=-10A	--	73	--	nC
Qgs	Gate-Source Charge		--	17	--	nC
Qgd	Gate-Drain Charge		--	9.1	--	nC
<b>Source-Drain Diode Characteristics</b>						
ISD	Source-Drain Current(Body Diode)		--	--	-30	A
VSD	Forward on Voltage	VGS=0V,IS=-10A	--	--	-1.2	V
trr	Reverse Recovery Time	IF=-10A , dI/dt=100A/μs , TJ=25°C	--	32	--	ns
Qrr	Reverse Recovery Charge		--	49	--	nc

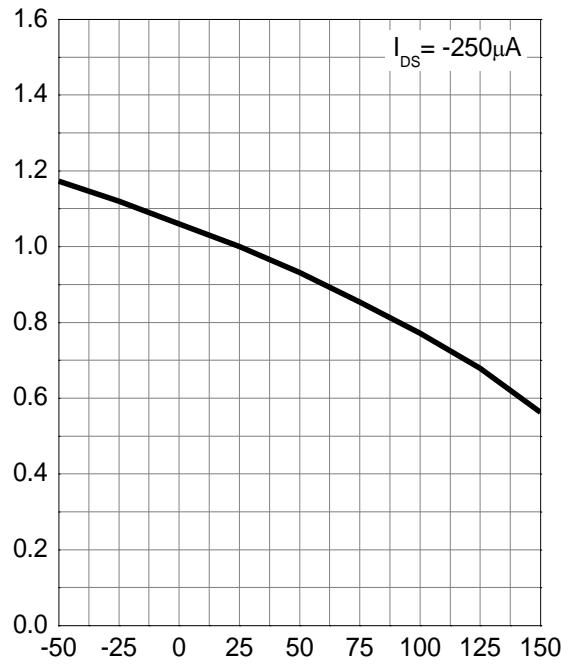
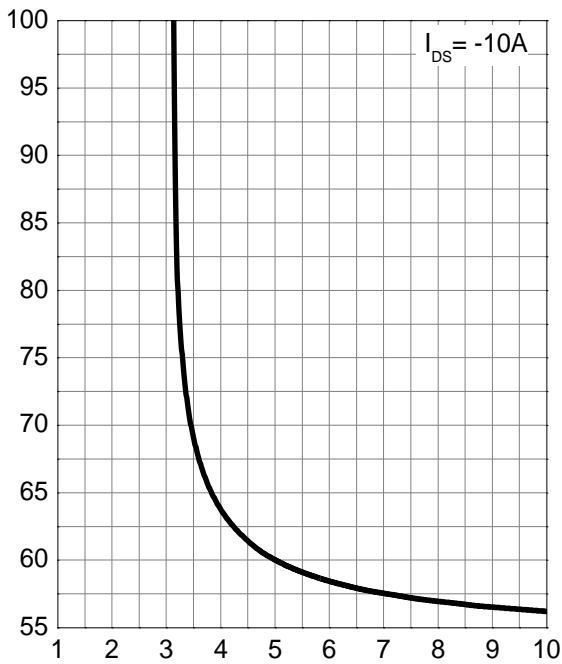
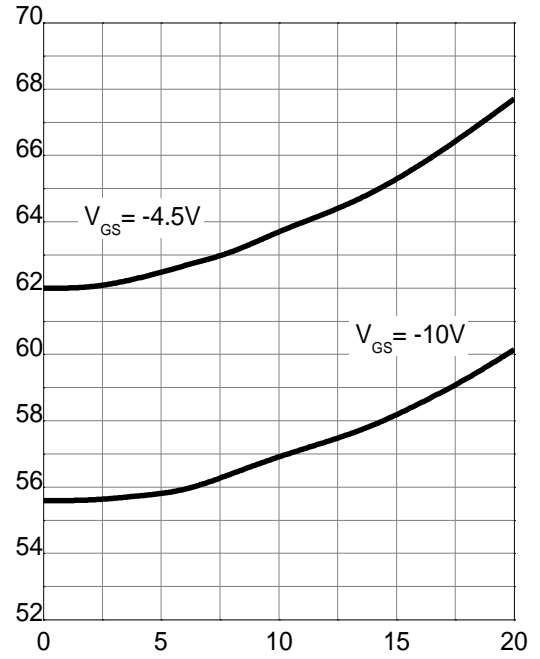
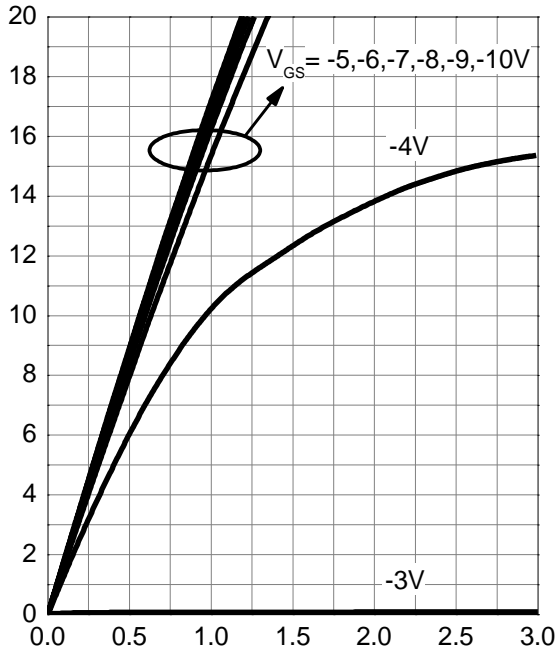
Notes 1.The maximum current rating is package limited.

Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature Notes 3.EAS condition: TJ=25°C

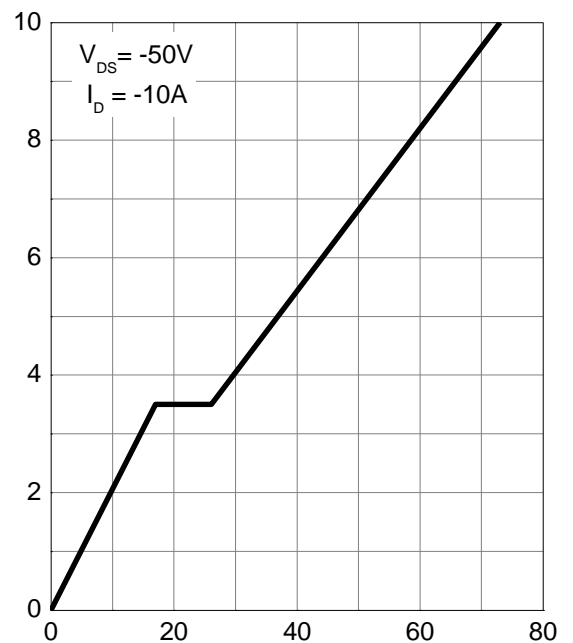
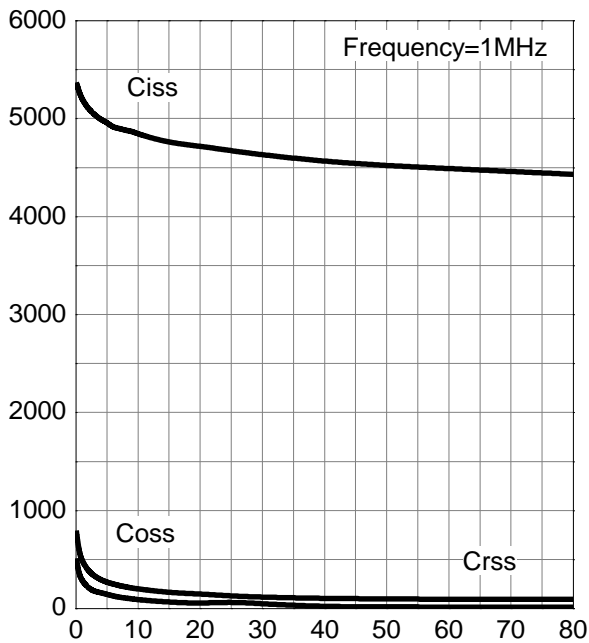
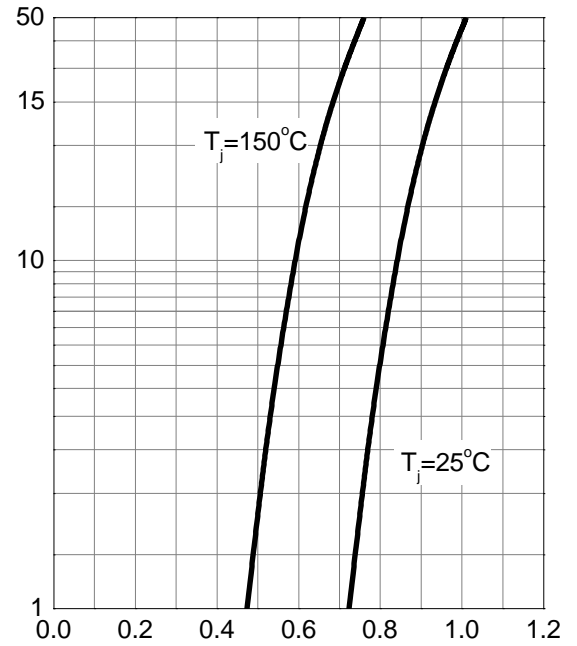
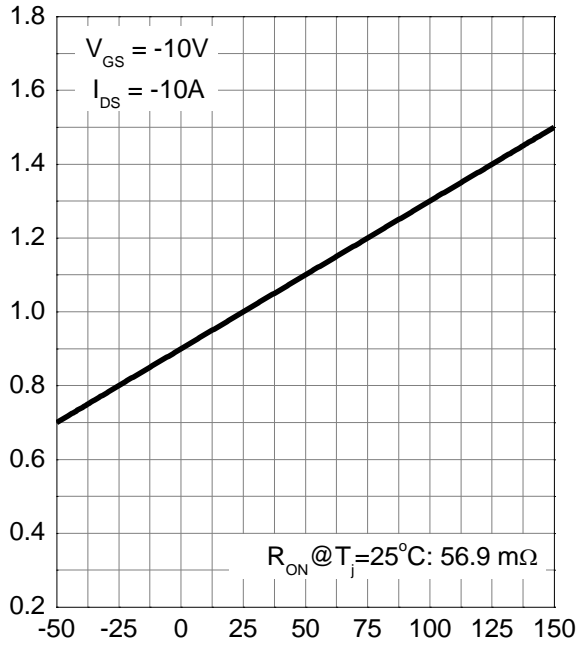
## 2. Typical Characteristics



### 3. Typical Characteristics (cont.)



## 4. Typical Characteristics (cont.)






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